

NCE N-Channel Super Trench Power MOSFET

Description

The NCEP02T10 uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

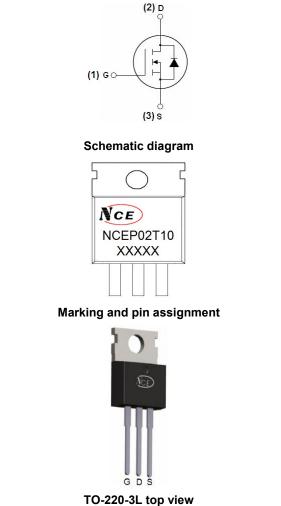
- V_{DS} =200V,I_D =100A
 R_{DS(ON)} <12mΩ @ V_{GS}=10V
- Excellent gate charge x R_{DS(on)} product
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

100% UIS TESTED!

100% ΔVds TESTED!



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Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP02T10	NCEP02T10	TO-220-3L	-	-	-

Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	200	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	ID	100	A
Drain Current-Continuous(Tc=100 ℃)	l _D (100℃)	70.7	А
Pulsed Drain Current	I _{DM}	400	А
Maximum Power Dissipation	PD	300	W
Derating factor		2	W/°C
Single pulse avalanche energy (Note 1)	E _{AS}	1216	mJ
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C



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Thermal Characteristic

Thermal Resistance, Junction-to-Case	Rejc	0.5	°C/W
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Electrical Characteristics (Tc=25[°]C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	i i					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	200	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =200V,V _{GS} =0V			1	μA
Gate-Body Leakage Current	age Current I _{GSS} V _{GS} =±20V,V _{DS} =0V		-	-	±100	nA
On Characteristics	I					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	2.5		4.5	V
Drain-Source On-State Resistance	R _{DS(ON)}	V_{GS} =10V, I _D =50A	-	10	12	mΩ
Forward Transconductance	g⊧s	V _{DS} =10V,I _D =50A	70	-	-	S
Dynamic Characteristics						
Input Capacitance	C _{lss}	N/ 400X/X/ 0X/	-	6000	-	PF
Output Capacitance	Coss	V_{DS} =100V, V_{GS} =0V,	-	425	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	16	-	PF
Switching Characteristics (Note 2)	L L					
Turn-on Delay Time	t _{d(on)}		-	18	-	nS
Turn-on Rise Time	tr	V_{DD} =100V, I_{D} =50A	-	26	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{G} =4.7 Ω	-	41	-	nS
Turn-Off Fall Time	t _f		-	11	-	nS
Total Gate Charge	Qg		-	87		nC
Gate-Source Charge	Q _{gs}	V _{DS} =100V,I _D =50A,	-	32		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	17.5		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =100A	-		1.2	V
Diode Forward Current	ls		-	-	100	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 50A	-	140		nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs	-	600		nC

Notes:

1. EAS condition : Tj=25 $^\circ\!\mathrm{C},V_{DD}$ =50V,V_G=10V,L=0.5mH,Rg=25 Ω

2. Guaranteed by design, not subject to production

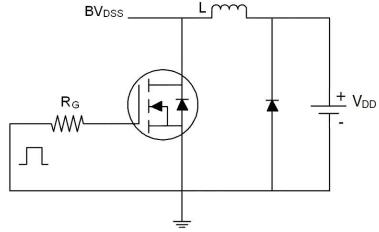
3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.



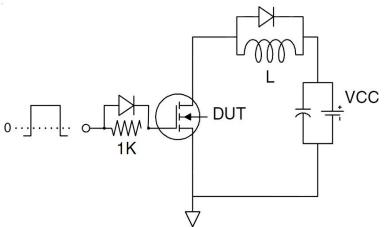
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Test Circuit

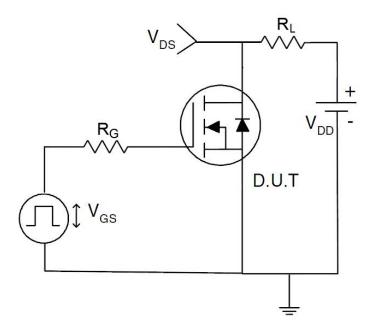
1) E_{AS} test Circuit



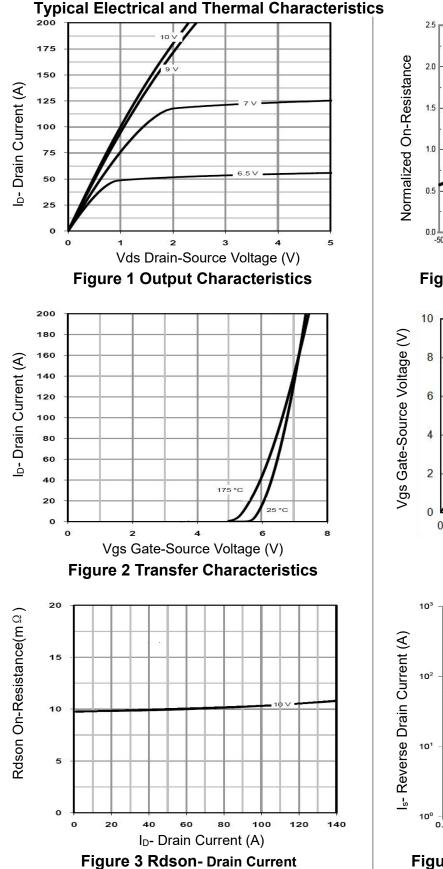
2) Gate charge test Circuit

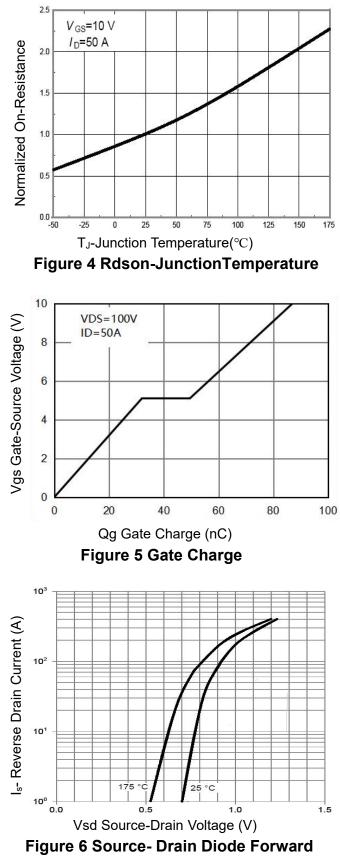


3) Switch Time Test Circuit



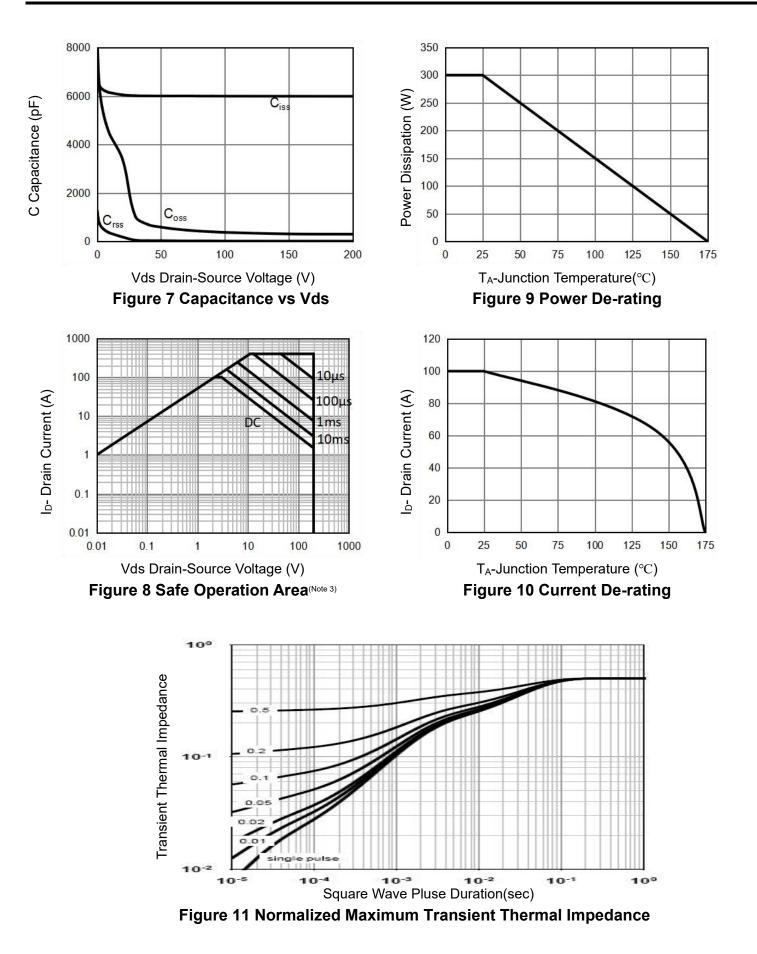






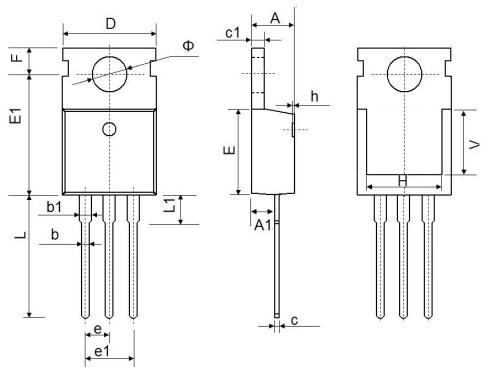


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TO-220-3L Package Information



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295 REF.		
Ф	3.400	3.800	0.134	0.150	



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